

Silicon N Channel MOS FET

REJ03G0984-0300

(Previous: ADE-208-1332)

Rev.3.00 Apr 27, 2006

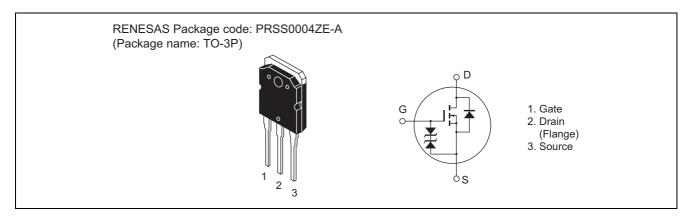
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- No secondary breakdown
- Suitable for switching regulator

Outline



A Solution Maximum 配atings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	900	V
Gate to source voltage	V_{GSS}	±30	V
Drain current	I _D	10	Α
Drain peak current	I _{D(pulse)} *1	30	Α
Body to drain diode reverse drain current	I _{DR}	10	Α
Channel dissipation	Pch*2	150	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

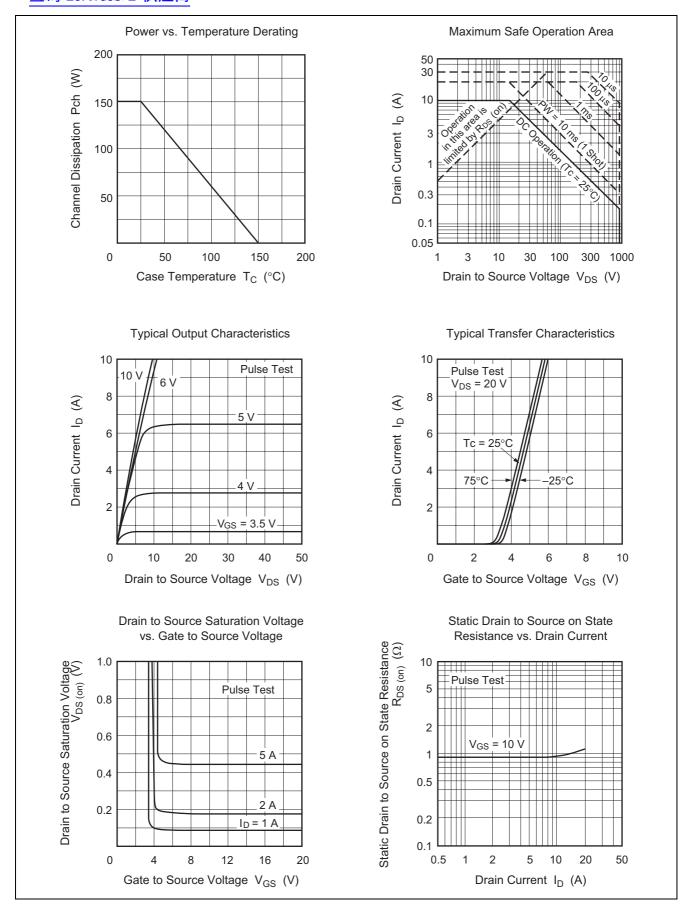
Electrical Characteristics

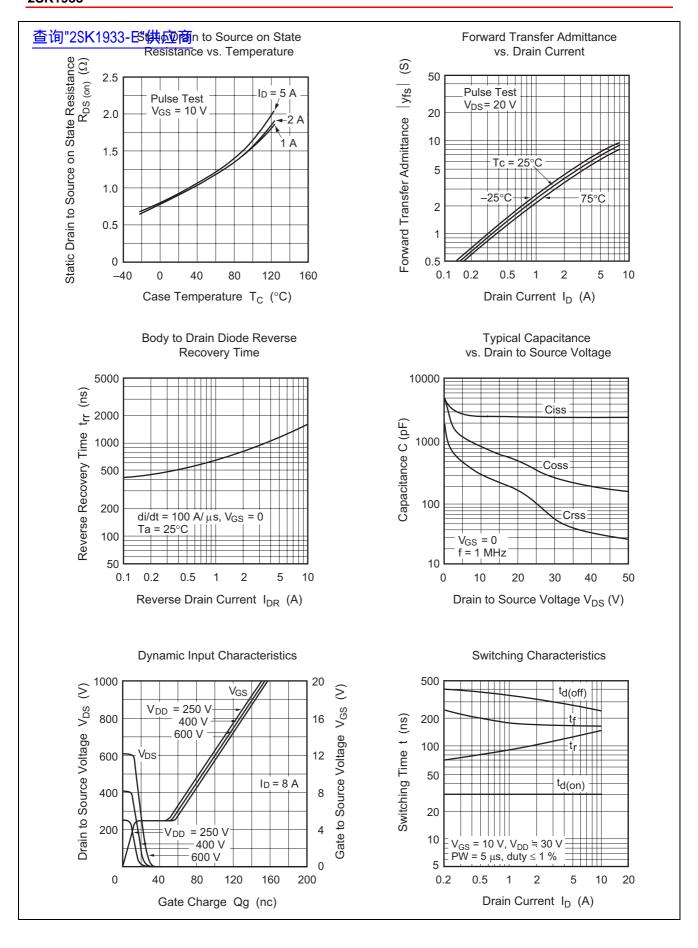
 $(Ta = 25^{\circ}C)$

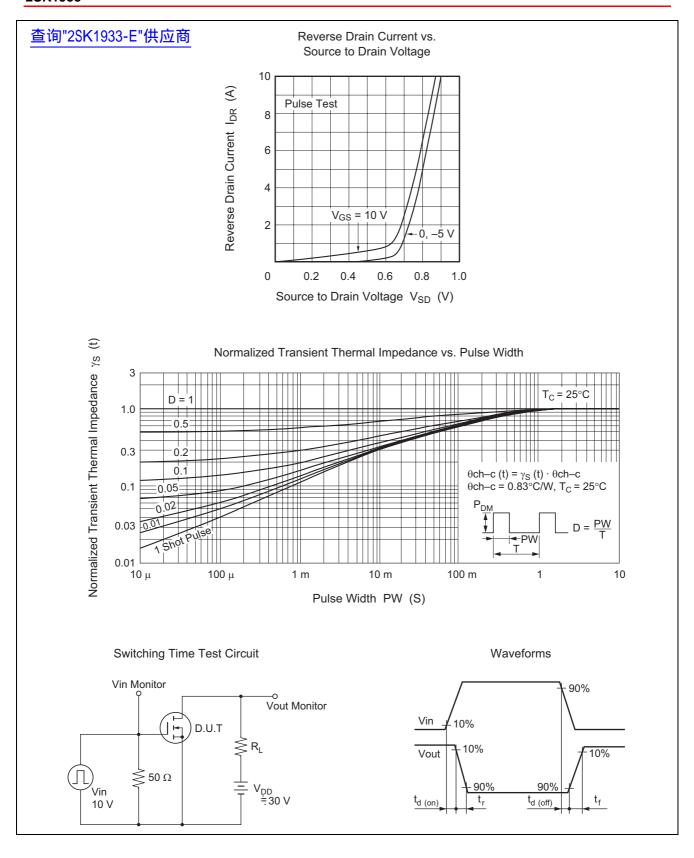
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	900	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±30	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	250	μΑ	V _{DS} = 720 V, V _{GS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	0.9	1.2	Ω	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V*}^1$
Forward transfer admittance	y _{fs}	4.5	7	_	S	$I_D = 5 \text{ A}, V_{DS} = 20 \text{ V}^{*1}$
Input capacitance	Ciss	_	2620	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	830	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	320	_	pF	
Turn-on delay time	t _{d(on)}	_	30	_	ns	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	t _r	_	140	_	ns	$R_L = 6 \Omega$
Turn-off delay time	$t_{d(off)}$	_	285	_	ns	
Fall time	t _f	_	170	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.9	_	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	1600	_	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu \text{s}$

Note: 1. Pulse Test

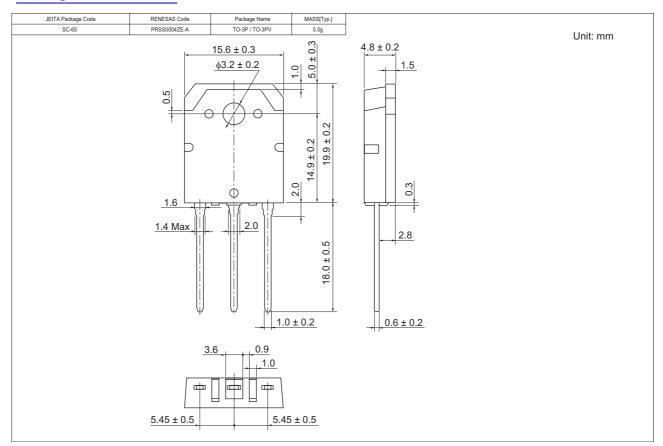
Main "Character"istics







Package Dimenstons



Ordering Information

Part Name	Quantity	Shipping Container
2SK1933-E	360 pcs	Box (Tube)

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